

Advanced Power MOSFET

SFS9510

FEATURES

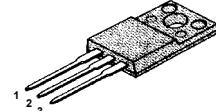
- Avalanche Rugged Technology
- Rugged Gate Oxide Technology
- Lower Input Capacitance
- Improved Gate Charge
- 175°C Operating Temperature
- Extended Safe Operating Area
- Lower Leakage Current : 10 µA (Max.) @ $V_{DS} = -100V$
- Low $R_{DS(ON)}$: 0.912 Ω (Typ.)

$BV_{DSS} = -100 V$

$R_{DS(on)} = 1.2 \Omega$

$I_D = -2.5 A$

TO-220F



1.Gate 2. Drain 3. Source

Absolute Maximum Ratings

Symbol	Characteristic	Value	Units
V_{DSS}	Drain-to-Source Voltage	-100	V
I_D	Continuous Drain Current ($T_C=25^\circ C$)	-2.5	A
	Continuous Drain Current ($T_C=100^\circ C$)	-1.8	
I_{DM}	Drain Current-Pulsed	① -10	A
V_{GS}	Gate-to-Source Voltage	± 20	V
E_{AS}	Single Pulsed Avalanche Energy	② 25	mJ
I_{AR}	Avalanche Current	① -2.5	A
E_{AR}	Repetitive Avalanche Energy	① 1.6	mJ
dv/dt	Peak Diode Recovery dv/dt	③ -6.5	V/ns
P_D	Total Power Dissipation ($T_C=25^\circ C$)	16	W
	Linear Derating Factor	0.11	$W/\text{ }^\circ C$
T_J, T_{STG}	Operating Junction and Storage Temperature Range	- 55 to +175	$^\circ C$
	Maximum Lead Temp. for Soldering Purposes, 1/8" from case for 5-seconds	300	

Thermal Resistance

Symbol	Characteristic	Typ.	Max.	Units
$R_{\theta JC}$	Junction-to-Case	--	9.38	$^\circ C/W$
$R_{\theta JA}$	Junction-to-Ambient	--	62.5	

SFS9510

P-CHANNEL
POWER MOSFET

Electrical Characteristics ($T_C=25^\circ\text{C}$ unless otherwise specified)

Symbol	Characteristic	Min.	Typ.	Max.	Units	Test Condition
BV_{DSS}	Drain-Source Breakdown Voltage	-100	--	--	V	$\text{V}_{\text{GS}}=0\text{V}, \text{I}_D=-250\mu\text{A}$
$\Delta \text{BV}/\Delta T_J$	Breakdown Voltage Temp. Coeff.	--	-0.1	--	V°C	$\text{I}_D=-250\mu\text{A}$ See Fig 7
$\text{V}_{\text{GS(th)}}$	Gate Threshold Voltage	-2.0	--	-4.0	V	$\text{V}_{\text{DS}}=-5\text{V}, \text{I}_D=-250\mu\text{A}$
I_{GSS}	Gate-Source Leakage , Forward	--	--	-100	nA	$\text{V}_{\text{GS}}=-20\text{V}$
	Gate-Source Leakage , Reverse	--	--	100		$\text{V}_{\text{GS}}=20\text{V}$
I_{DSS}	Drain-to-Source Leakage Current	--	--	-10	μA	$\text{V}_{\text{DS}}=-100\text{V}$
		--	--	-100		$\text{V}_{\text{DS}}=-80\text{V}, \text{T}_C=150^\circ\text{C}$
$\text{R}_{\text{DS(on)}}$	Static Drain-Source On-State Resistance	--	--	1.2	Ω	$\text{V}_{\text{GS}}=-10\text{V}, \text{I}_D=-1.3\text{A}$ ④
g_{fs}	Forward Transconductance	--	1.6	--	mS	$\text{V}_{\text{DS}}=-40\text{V}, \text{I}_D=-1.3\text{A}$ ④
C_{iss}	Input Capacitance	--	260	335	pF	$\text{V}_{\text{GS}}=0\text{V}, \text{V}_{\text{DS}}=-25\text{V}, f=1\text{MHz}$ See Fig 5
C_{oss}	Output Capacitance	--	50	80		
C_{rss}	Reverse Transfer Capacitance	--	17	25		
$t_{\text{d(on)}}$	Turn-On Delay Time	--	10	30	ns	$\text{V}_{\text{DD}}=-50\text{V}, \text{I}_D=3.6\text{A}, \text{R}_G=24\Omega$ See Fig 13 ④⑤
t_r	Rise Time	--	20	50		
$t_{\text{d(off)}}$	Turn-Off Delay Time	--	25	60		
t_f	Fall Time	--	12	35		
Q_g	Total Gate Charge	--	9	10	nC	$\text{V}_{\text{DS}}=-80\text{V}, \text{V}_{\text{GS}}=-10\text{V}, \text{I}_D=-3.6\text{A}$ See Fig 6 & Fig 12 ④⑤
Q_{gs}	Gate-Source Charge	--	1.5	--		
Q_{gd}	Gate-Drain("Miller") Charge	--	4.3	--		

Source-Drain Diode Ratings and Characteristics

Symbol	Characteristic	Min.	Typ.	Max.	Units	Test Condition
I_s	Continuous Source Current	--	--	-2.5	A	Integral reverse pn-diode in the MOSFET
I_{SM}	Pulsed-Source Current ①	--	--	-10		
V_{SD}	Diode Forward Voltage ④	--	--	-3.8	V	$\text{T}_J=25^\circ\text{C}, \text{I}_s=-2.5\text{A}, \text{V}_{\text{GS}}=0\text{V}$
t_{rr}	Reverse Recovery Time	--	100	--	ns	$\text{T}_J=25^\circ\text{C}, \text{I}_F=-3.6\text{A}$ $d\text{I}_F/dt=100\text{A}/\mu\text{s}$ ④
Q_{rr}	Reverse Recovery Charge	--	0.35	--		

Notes :

- ① Repetitive Rating : Pulse Width Limited by Maximum Junction Temperature
- ② $L=6.0\text{mH}, \text{I}_{\text{AS}}=-2.5\text{A}, \text{V}_{\text{DD}}=-25\text{V}, \text{R}_G=27\Omega^*$, Starting $\text{T}_J=25^\circ\text{C}$
- ③ $\text{I}_{\text{SD}} \leq -3.6\text{A}, d\text{I}/dt \leq 300\text{A}/\mu\text{s}, \text{V}_{\text{DD}} \leq \text{BV}_{\text{DSS}}$, Starting $\text{T}_J=25^\circ\text{C}$
- ④ Pulse Test : Pulse Width = $250\mu\text{s}$, Duty Cycle $\leq 2\%$
- ⑤ Essentially Independent of Operating Temperature

**P-CHANNEL
POWER MOSFET**

SFS9510

Fig 1. Output Characteristics

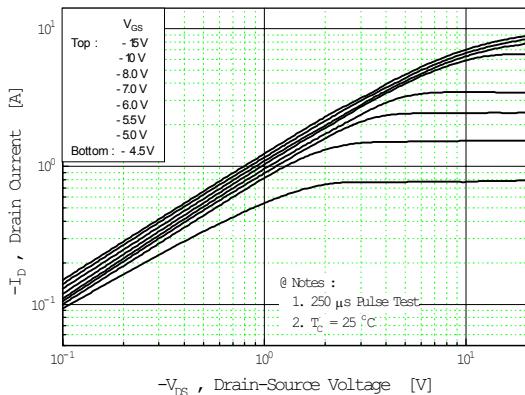


Fig 2. Transfer Characteristics

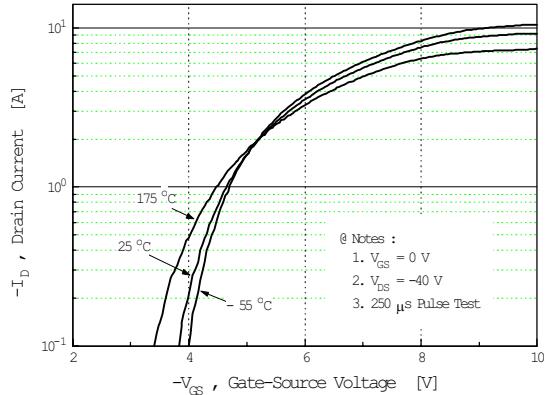


Fig 3. On-Resistance vs. Drain Current

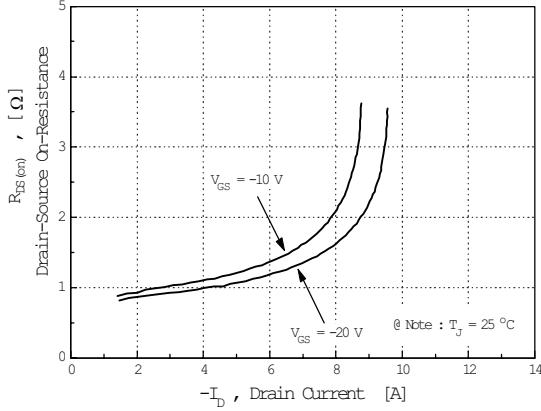


Fig 4. Source-Drain Diode Forward Voltage

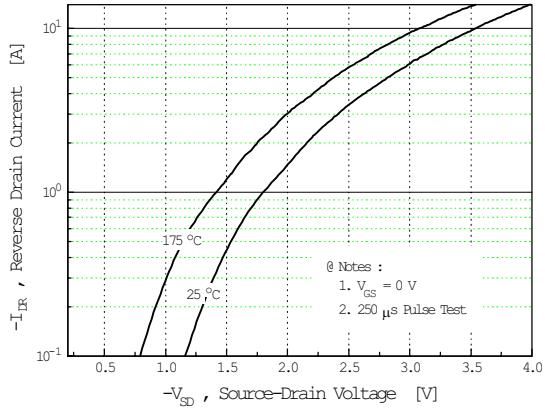


Fig 5. Capacitance vs. Drain-Source Voltage

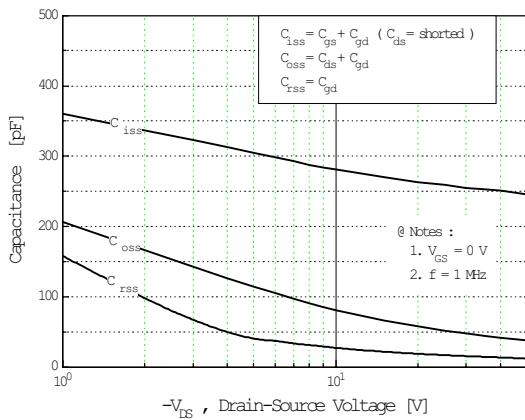
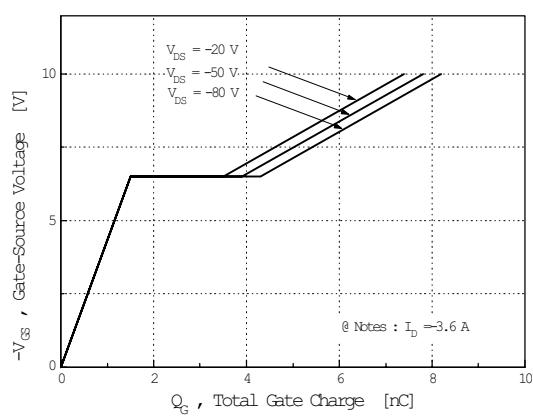


Fig 6. Gate Charge vs. Gate-Source Voltage



SFS9510

P-CHANNEL
POWER MOSFET

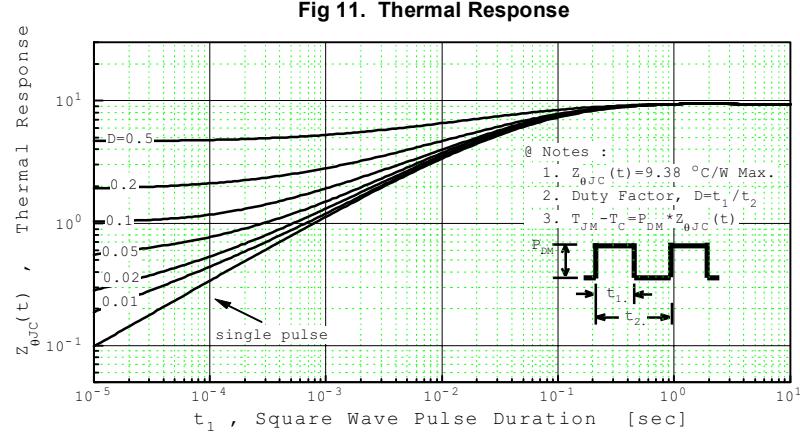
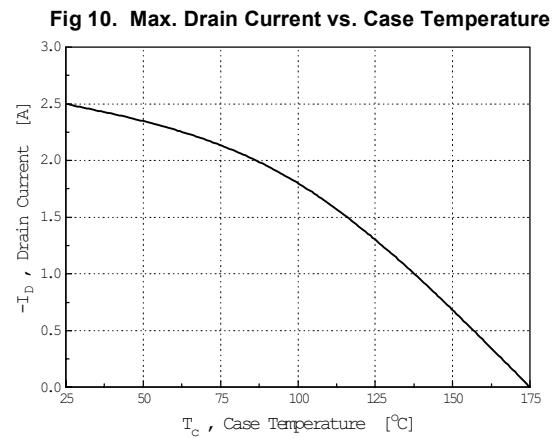
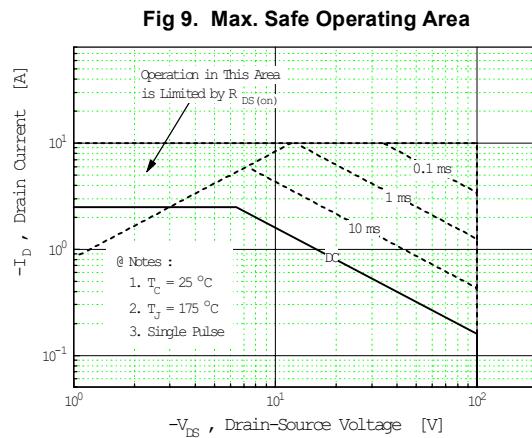
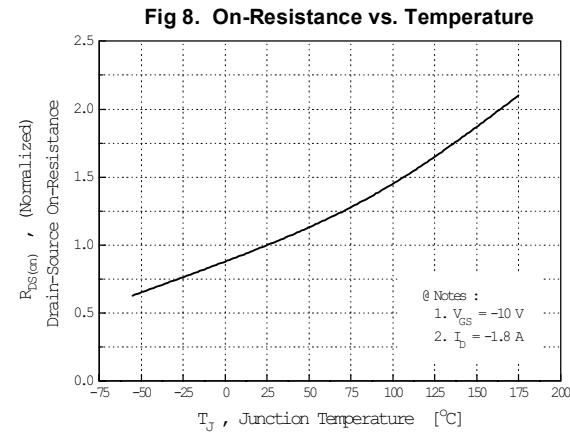
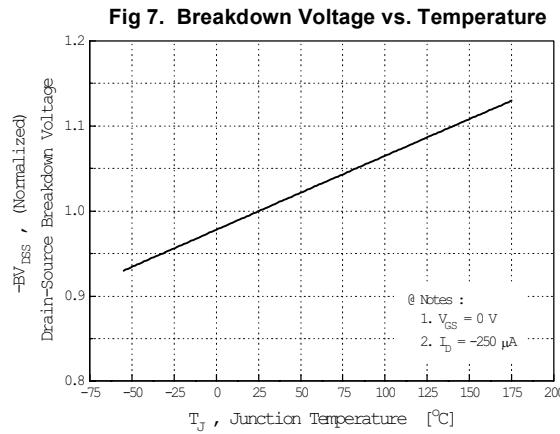


Fig 12. Gate Charge Test Circuit & Waveform

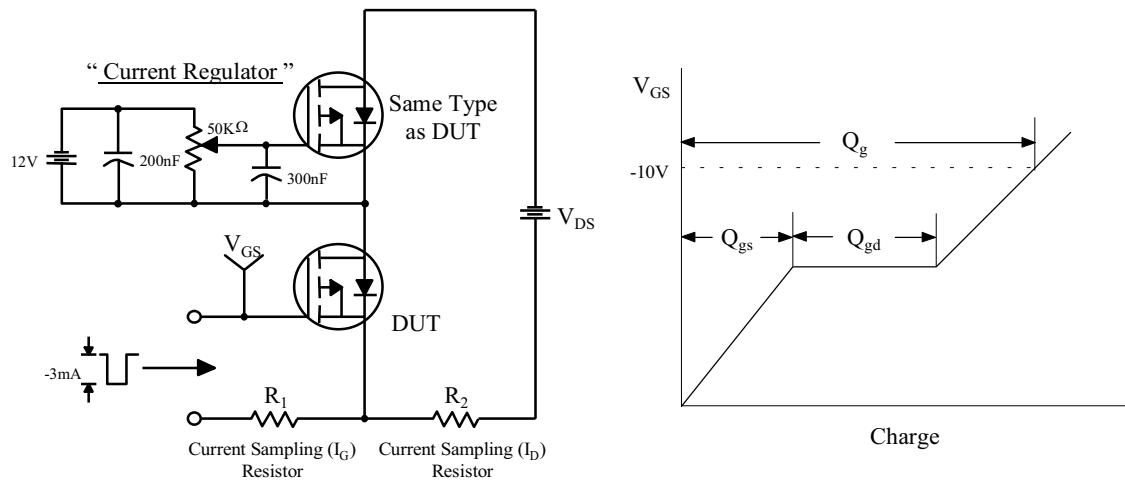


Fig 13. Resistive Switching Test Circuit & Waveforms

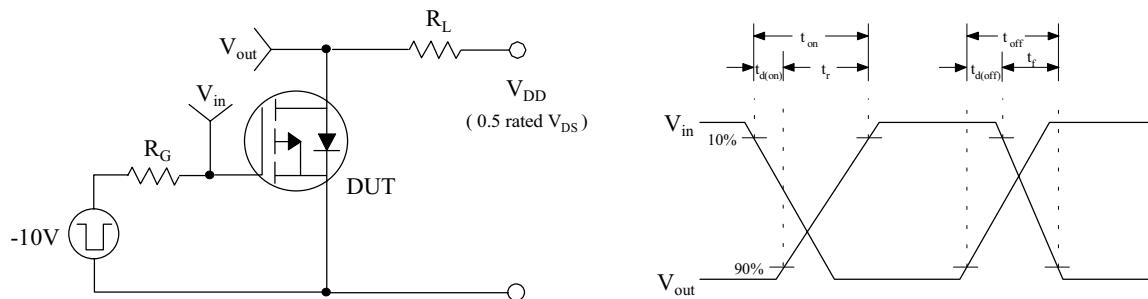
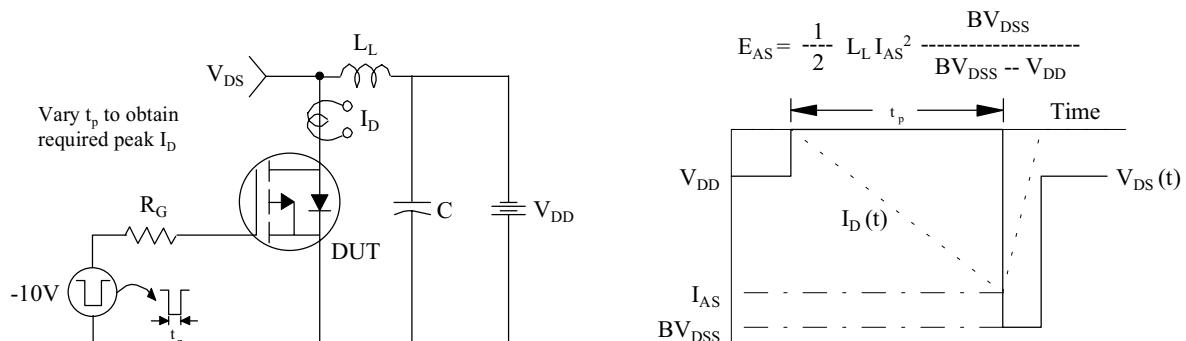


Fig 14. Unclamped Inductive Switching Test Circuit & Waveforms



SFS9510

P-CHANNEL
POWER MOSFET

Fig 15. Peak Diode Recovery dv/dt Test Circuit & Waveforms

